# INTERNATIONAL STANDARD

IEC 62314

First edition 2006-05

## Solid-state relays

© IEC 2006 — Copyright - all rights reserved

No part of this publication may be reproduced or utilized in any form or by any means, electronic or mechanical, including photocopying and microfilm, without permission in writing from the publisher.

International Electrotechnical Commission, 3, rue de Varembé, PO Box 131, CH-1211 Geneva 20, Switzerland Telephone: +41 22 919 02 11 Telefax: +41 22 919 03 00 E-mail: inmail@iec.ch Web: www.iec.ch



PRICE CODE



## **CONTENTS**

FO	REW	ORD	4	
1	Sco	pe and object	6	
2	Norr	native references	7	
3	Tern	ns and definitions	8	
4	Characteristics of solid-state relays			
	4.1	Summary of characteristics	12	
	4.2	Type of solid-state relay		
	4.3	Rated and limiting values for load circuits	12	
	4.4	Load category	13	
	4.5	Rated and limiting values for control circuits		
5	Marking and documentation			
	5.1	Marking	14	
	5.2	Data	15	
	5.3	Instructions for installation, operation and maintenance		
6	Norr	mal conditions	15	
	6.1	Normal service, transport and storage conditions		
	6.2	Normal mounting conditions		
7	Con	structional requirements	16	
	7.1	Materials		
	7.2	Clearances and creepage distances		
	7.3	Heat and fire resistance		
_	7.4	Terminals		
8		ormance requirements		
	8.1	Temperature-rise		
	8.2	Overload test		
	8.3	Endurance test	_	
	8.4	Insulation tests		
	8.5 8.6	Impact test Ball pressure test		
	8.7	OFF-state leakage current measurement		
	8.8	ON-state voltage drop measurement		
9		e test		
An	nex A	(normative) Insulation coordination	23	
Annex B (normative) Glow-wire test				
An	nex C	(normative) Quick-connect terminations	37	
Fig	ure B	.1 – Glow-wire and position of the thermocouple	35	
Fig	ure B	.2 – Glow-wire test apparatus (example)	36	

### This is a preview - click here to buy the full publication

## 62314 © IEC:2006(E)

## - 3 -

Table 1 – Load categories	13
Table 2 – Required data	15
Table 3 – Test conditions for test Tb	17
Table 4 – Minimum requirements for overload capability test conditions	19
Table 5 – Endurance test	20
Table A.1 – Rated impulse withstand voltages (waveform: 1,2/50 µs) for solid-state relays connected directly to the mains	24
Table A.2 – Minimum clearances	26
Table A.3 – Minimum creepage distances for solid-state relays	27
Table A.4 – Preconditioning	29
Table C.1 – Cross-sectional areas for conductors depending on the resistive current carried by the terminal	38

#### INTERNATIONAL ELECTROTECHNICAL COMMISSION

#### SOLID-STATE RELAYS

#### **FOREWORD**

- 1) The International Electrotechnical Commission (IEC) is a worldwide organization for standardization comprising all national electrotechnical committees (IEC National Committees). The object of IEC is to promote international co-operation on all questions concerning standardization in the electrical and electronic fields. To this end and in addition to other activities, IEC publishes International Standards, Technical Specifications, Technical Reports, Publicly Available Specifications (PAS) and Guides (hereafter referred to as "IEC Publication(s)"). Their preparation is entrusted to technical committees; any IEC National Committee interested in the subject dealt with may participate in this preparatory work. International, governmental and non-governmental organizations liaising with the IEC also participate in this preparation. IEC collaborates closely with the International Organization for Standardization (ISO) in accordance with conditions determined by agreement between the two organizations.
- 2) The formal decisions or agreements of IEC on technical matters express, as nearly as possible, an international consensus of opinion on the relevant subjects since each technical committee has representation from all interested IEC National Committees.
- 3) IEC Publications have the form of recommendations for international use and are accepted by IEC National Committees in that sense. While all reasonable efforts are made to ensure that the technical content of IEC Publications is accurate, IEC cannot be held responsible for the way in which they are used or for any misinterpretation by any end user.
- 4) In order to promote international uniformity, IEC National Committees undertake to apply IEC Publications transparently to the maximum extent possible in their national and regional publications. Any divergence between any IEC Publication and the corresponding national or regional publication shall be clearly indicated in the latter
- 5) IEC provides no marking procedure to indicate its approval and cannot be rendered responsible for any equipment declared to be in conformity with an IEC Publication.
- 6) All users should ensure that they have the latest edition of this publication.
- 7) No liability shall attach to IEC or its directors, employees, servants or agents including individual experts and members of its technical committees and IEC National Committees for any personal injury, property damage or other damage of any nature whatsoever, whether direct or indirect, or for costs (including legal fees) and expenses arising out of the publication, use of, or reliance upon, this IEC Publication or any other IEC Publications
- 8) Attention is drawn to the Normative references cited in this publication. Use of the referenced publications is indispensable for the correct application of this publication.
- 9) Attention is drawn to the possibility that some of the elements of this IEC Publication may be the subject of patent rights. IEC shall not be held responsible for identifying any or all such patent rights.

International Standard IEC 62314 has been prepared by technical committee 94: All-or-nothing electrical relays.

The text of this standard is based on the following documents:

FDIS	Report on voting
94/232/FDIS	94/235/RVD

Full information on the voting for the approval of this standard can be found in the report on voting indicated in the above table.

This publication has been drafted in accordance with the ISO/IEC Directives, Part 2.

62314 © IEC:2006(E)

– 5 –

The committee has decided that the contents of this publication will remain unchanged until the maintenance result date indicated on the IEC web site under "http://webstore.iec.ch" in the data related to the specific publication. At this date, the publication will be

- reconfirmed;
- withdrawn;
- · replaced by a revised edition, or
- amended.

A bilingual version of this publication may be issued at a later date.

#### **SOLID-STATE RELAYS**

#### 1 Scope and object

This International Standard applies to particular all-or-nothing electrical relays denominated solid-state relays intended for performing electrical operations by single step function changes to the state of electric circuits between the OFF-state and the ON-state and vice versa. It is applicable to solid-state relays with rated voltages up to 750 V and with a.c. output current up to 160 A.

NOTE Requirements for solid-state relays with d.c. output circuits are under consideration.

This standard deals with solid-state relays which are intended for incorporation in other products or equipment. As such, solid state relays are considered to be components and this standard defines the basic safety-related and functional requirements for solid-state relays as stand-alone components.

Such solid-state relays are incorporated in products or equipment which themselves have to comply with the relevant product and/or application standard(s) to meet their intended application. The following are examples of such applications:

- general industrial equipment;
- electrical facilities;
- electrical machines:
- electrical appliances;
- office communications;
- building automation and environmental control;
- automation and process control;
- electrical installation engineering;
- medical engineering;
- telecommunications;
- vehicle engineering;
- transportation engineering;
- lighting control.

Solid state relays are components (not stand alone devices) and as such do not perform a direct function. Therefore, no EMC requirements are included in this standard.

NOTE This is in line with the European EMC Directive.

Where the application of a solid-state relay determines additional requirements such as EMC and overcurrent protection, the solid-state relay shall be assessed in accordance with the relevant IEC standard(s).

Solid-state switching devices with monolithic structures fall within the scope of IEC sub-committee 47E and are not covered in this standard.

Semiconductor controllers and contactors fall within the scope of the IEC 60947 series of standards – *Low-voltage switchgear and controlgear* – developed by IEC subcommittee 17B and are not covered in this standard.

Compliance with the requirements of this standard is verified by the type tests indicated.

62314 © IEC:2006(E)

**-7-**

The object of this standard is to state:

- the characteristics of solid-state relays;
- the requirements which solid-state relays shall comply with reference to
  - a) their operation and behaviour;
  - b) their dielectric properties;
  - c) the degrees of protection provided by their enclosures, where applicable;
- the tests verifying that the requirements have been met, and the test methods to be adopted;
- the information to be given with the solid-state relay or in the manufacturer's documentation.

#### 2 Normative references

The following referenced documents are indispensable for the application of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

IEC 60038:1983, IEC standard voltages Amendment 1 (1994) Amendment 2 (1997)

IEC 60050-195:1998, International Electrotechnical Vocabulary (IEV) – Part 195: Earthing and protection against electric shock

IEC 60050-444:2002, International Electrotechnical Vocabulary (IEV) – Part 444: Elementary relays

IEC 60068-2-1:1990, Environmental testing - Part 2: Tests. Tests A: Cold

IEC 60068-2-2:1974, Environmental testing - Part 2: Tests. Tests B: Dry heat

IEC 60068-2-14:1984, Environmental testing – Part 2: Tests. Test N: Change of temperature Amendment 1 (1986)

IEC 60068-2-20:1979, Environmental testing – Part 2: Tests. Test T: Soldering Amendment 2 (1987)

IEC 60068-2-78:2001, Environmental testing – Part 2-78: Tests – Test Cab: Damp heat, steady state

IEC 60112:2003, Method for the determination of the proof and the comparative tracking indices of solid insulating materials

IEC 60529, Degrees of protection provided by enclosures (IP Code)

IEC 60664-1, Insulation coordination for equipment within low-voltage systems – Part 1: Principles, requirements and tests

IEC 60664-3:2003, Insulation coordination for equipment within low-voltage systems – Part 3: Use of coating, potting or moulding for protection against pollution

IEC 60695-2-10:2000, Fire hazard testing – Part 2-10: Glowing/hot-wire based test methods – Glow-wire apparatus and common test procedure

IEC 60695-10-2:2003, Fire hazard testing - Part 10-2: Abnormal heat - Ball pressure test

IEC 60695-11-10:2003, Fire hazard testing – Part 11-10: Test flames – 50 W horizontal and vertical flame test methods

IEC 60999-1:1999, Connecting devices – Electrical copper conductors – Safety requirements for screw-type and screwless-type clamping units – Part 1: General requirements and particular requirements for clamping units for conductors from 0,2 mm² up to 35 mm² (included)

IEC 61210:1993, Connecting devices – Flat quick-connect terminations for electrical copper conductors – Safety requirements

IEC 61760-1:1998, Surface mounting technology – Part 1: Standard method for the specification of surface mounting components (SMDs)